# VERSAFLOW 3/66 Modular selective platform for highly flexible inline soldering of XL boards









# Ersa VERSAFLOW 3/66 The worldwide leading selective system for PCBs in XL format



## Highlights

- High-end selective soldering system for the integration in inline production concepts
- Parallel process due to the separation of fluxing, preheating and soldering
- Operation of up to four spray heads
- Flexible system configuration due to modular concept
- Perfect for the connection to assembly stands and periphery
- Maximum PCB size 610 x 610 mm

In order to meet all requirements in terms of flexibility, the thirdgeneration VERSAFLOW has been created as a modular platform. The VERSAFLOW 3/66 belongs to this generation of machines and is especially designed for the selective soldering of PCBs in "XL" format. PCBs with dimensions of up to 610 mm x 610 mm pose no problem for this modern soldering system.

The basic version of the VERSA-FLOW 3/66 includes a flux module, a preheat module and a solder module with a segmented transport. Depending on the soldering task at hand and the required throughput, it is possible to integrate additional flux, preheat and solder modules. This allows the VER-SAFLOW 3/66 to be equipped with up to three solder modules which can each be fitted with one or two single nozzle solder pots. An additional preheating can be added in front of each solder module in order to consistently guarantee the ideal heating of the PCB. Both the preheating and the solder modules can also be optionally equipped with an additional upper preheating.

An optional dual-track transport is available to increase the throughput of the selective soldering system. While the system's floor space remains constant, this allows to process PCBs simultaneously on two tracks. All other options are also available in the XL format, so that, just like the Ersa standard, this selective system can be optimally adapted to each customer's needs. This guarantees consistent, repeatable soldering processes of the highest quality.



Dual track conveyor



Long solder nozzle for PCBs with high components on soldering side



Perfect preheat concept with dynamic lower and upper preheaters

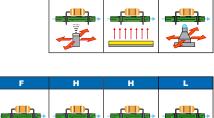


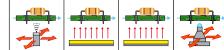
### **Basic configuration**

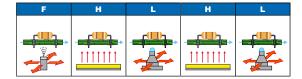
- Segmented pin-and-chain/roller conveyor
- High-precision spray fluxer with spray test function and flux level monitoring
- Bottom-side IR preheater
- Maximum PCB size 610 x 610 mm
- PC control
- Process visualization including solder protocol, process data writer, monitoring function, maintenance and error message indication, password protection
- Exhaust air monitoring
- Solder bath with electromagnetic solder pump
- Solder level- and solder wave height monitoring

#### The Ersa Modular System

Below combinations of the arrangement of different modules show onlysome of the possibilities of the extremely flexible Ersa modular system concept. Depending on a customer's request, with the addition of the optional dual pot feature and/or the dual track feature, throughput could be substantially enhanced without increasing floor space requirements.



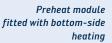


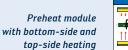


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### Legende:

Flux module fitted with spray fluxer





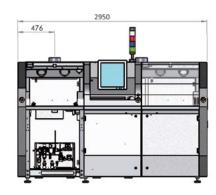


Solder module with single wave unit



with single wave unit

# Technical data VERSAFLOW 3/66



VERSAFLOW 3/66 (basic system))	VERSAF	LOW 3/66	(basic sy	stem))
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Length:	2.950 mm
Width:	1.900 mm
Height:	1.650 mm
Weight:	approx. 1.700 kg
Туре:	inline
PCB loading:	manual/automatic

#### **Electrical data**

Power:	5-wire system, 3 x 230/400 V, N, PE	
Power tolerance rang	je: + 6 %, -10 %	
Frequency:	50/60 Hz	
Power consumption:	30 kW	
Safety fuse:	max. 45 A	

## Conveyor system

Туре:	Type: Segmented pin-and-chain		
conv	eyor/roller co	nveyor for PCB	
transpo	ort without wo	rkpiece carrier	
PCB width:		60 – 610 mm	
PCB length:		120 – 610 mm	
Clearance fro	m PCB edge:	3 mm	
PCB top-side	clearance:	max. 120 mm	
PCB bottom-side clearance: max. 30 mm			
Speed:		0.2 - 10 m/min	
Mask/PCB we (heavy load co	-	8 kg nal) (15 kg)	

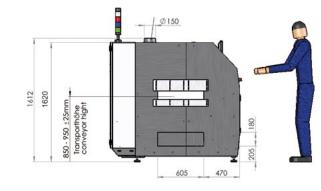
#### America

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### Mexico

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## Flux module

Туре:	Type: high-precision spray fluxer	
Positioning system:		2 axis,
		servo motor driven
Flux storage	tank:	1.8
Positioning s	peed:	1 – 400 mm/s
Fluxer speed:		20 mm/s
Positioning a	ccuracy:	±0.25 mm
Spray width:	2 – 8 r	nm (130 µm nozzle)

## Preheat module

Туре:	IR bottom-side (basis),	
	top-side convection (option),	
Power:	12 kW	
Temperatur	e: bis 200 °C	

#### Miniwave solder module

Solder wave height:	max. 5 mm
Clearance from PCB e	dge: min. 3 mm
	orox. 14 kg (Sn63Pb) ox. 13 kg (lead-free)
Solder temperature:	max. 330 °C
Warm-up time:	75 min to 280 °C
Positioning speed	x/y: 2 - 200 mm/s z: 2 - 100 mm/s
Soldering speed:	10 mm/s
Positioning accuracy:	±0,25 mm

#### Asia

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## Nitrogen technology

Nitrogen supply:	to be supplied locally
Nitrogen injection:	N <sub>2</sub> cover over the solder bath
Required pressure:	6 bar
Consumption:	approx. 2 m³/h per pot
Particle cleanlines (recommendation)	s: 5.0

# Compressed air

Compressed air supply:	to be supplied
	locally
Required pressure:	6 bar
Consumption:	< 5 m³/h

## Exhaust rating

Exhaust stacks:	2 pc., OD 150 mm
Exhaust volume	250/200 m³/h
per stack:	

Environmental specs	/noise level
Ambient temperature:	15 - 35 °C
Permanent sound level:	< 65 dB (A)

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